

MHF® 4 / 4L Connector

Part No. MHF 4L Plug: 20565-001R-13, 20572-001R-08 MHF 4 Receptacle: 20449-001E-**

Product Specification

Qualification Test Report No. TR-13011

16	S22368	August 30, 2022	M. Hidaka	K. Yufu	Y. Hashimoto
15	S22251	June 16, 2022	H. Lu	Y. Shimizu	M. Takemoto
14	S22219	June 1, 2022	K. Watanabe	K. Yufu	Y. Hashimoto
13	S21509	October 22, 2021	K. Ikeshita		M. Takemoto
Rev.	ECN	Date	Prepared by	Checked by	Approved by
Confidential C			I-PEX Inc.		QKE-DFFDE06-08 REV.9

1. Scope

This Product Specification defines the test conditions and the performances of the MHF 4 / 4L Connector Test method is complied with "PCI Express® M.2 Electromechanical Specification DRAFT Revision 0.9".

2. Product Name and Parts No.

2.1 Product Name

MHF 4 / 4L Connector

2.2 Parts No.

MHF 4L Plug: 20565-001R-13, 20572-001R-08 MHF 4 Receptacle: 20449-001E-**

3. Rating

3.1 Applicable cable

3.1.1 Part No. 20565-001R-13

(1) Description

Inner conductor: AWG#32(7/0.08), Silver plating copper wire

Dielectric core: Fluoro-plastics, diameter 0.68(+0.04,-0.02)mm

Outer conductor: Braid of 0.05mm, diameter 0.93(±0.09)mm, silver plating copper wire

or tin plating copper wire

Jacket: Fluoro-plastics, diameter 1.13(+0.08,-0.05)mm

(2) Requirements

Characteristic impedance: $50\pm 2\Omega$ by TDR method Nominal capacitance(Reference value): 97 pF/m Dielectric withstand voltage: no breakdown at AC 500V for 1 minutes.

3.1.2 Part No. 20572-001R-08

(1) Description

Inner conductor : AWG#36(7/0.05) ,Silver plating copper wire

Dielectric core : Fluoro-plastics ,diameter 0.40(+0.04,-0.02)mm

 $Outer \ conductor: Braid \ of \ 0.05mm, \ diameter \ 0.65(\pm 0.1)mm \ , \ silver \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ or \ tin \ plating \ copper \ wire \ tin \ plating \ copper \ wire \ tin \ plating \ copper \ wire \ wire \ tin \ plating \ copper \ wire \ wire \ wire \ wire \ wire \ tin \ plating \ tin \ tin \ plating \ tin \ wire \ wir$

Jacket : Fluoro-plastics , diameter 0.81(+0.04,-0.03)mm

(2) Requirements

Characteristic impedance : $50\pm 3\Omega$ by TDR method Nominal capacitance(Reference value): 96 pF/m Dielectric withstand voltage : no breakdown at AC 1,000V for 1 minutes.

3.2 Conditions

Voltage: 60 Vr.m.s AC Operating Temperature: 233~363K(-40°C~+90°C)

(Containing temperature rise by current)

Nominal characteristic impedance: 50Ω

Frequency: DC~9 GHz

VSWR: [Plug]	1.30 MAX at 0.1~3 GHz
	1.45 MAX at 3~6 GHz
	1.60MAX at 6~9 GHz
	1.90MAX at 9~12 GHz
[Receptacle]	1.30 MAX at 0.1~3 GHz
	1.40 MAX at 3~6 GHz
	1.55 MAX at 6~9 GHz

3.3 Storage Conditions

Storage temperature: 248 to 333K(-25°C to 60°C) Storage humidity: 85% max. (Non-condensing)

4. Test and Performance

Test Condition

This initial test is equal to it's at shipping condition and unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature... 288K \sim 308K (15°C \sim 35°C) Pressure... 866hPa \sim 1066hPa (650mmHg \sim 800mmHg) Relative humidity... 45 \sim 75%R.H.

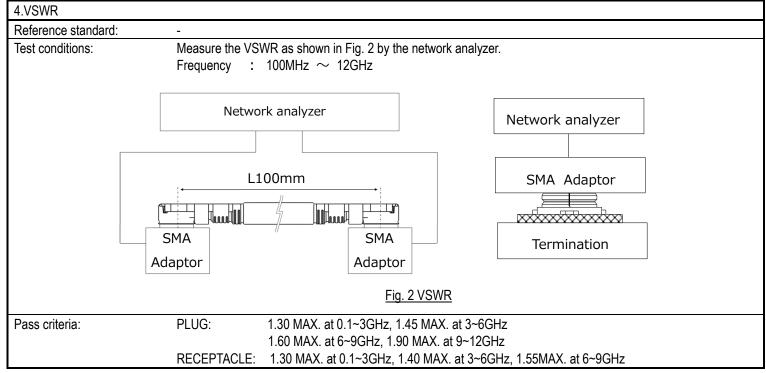
4.1. Electrical Performance

1. Contact resistance		
Reference standard:	MIL-STD-202-307	
Test conditions:		mate the plug connector together, then measure the contac nods. Apply the low level condition of 20mV MAX. DC for the d circuit current.
		Inner contact =A-B <u>Ground contact</u> =D-C
	Fig. 1 Contact resistance	2
Pass criteria:	Contact Initial: 20 m Ω MAX. After testing: \square R20 m Ω MAX. Ground contact Initial: 20 m Ω MAX. After testing: \square R20 m Ω MAX.	

2. Insulation resistance	
Reference standard:	MIL-STD-202-302
Test conditions:	Mate the plug and receptacle connector together, and then apply DC 100 V between the inner contact and the ground contact.
Pass criteria:	Initial: 500 M Ω MIN. After testing: 100 M Ω MIN.

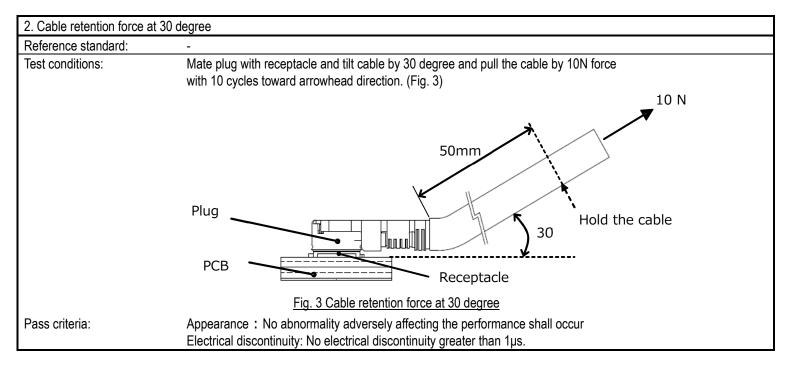
3. Dielectric withstanding	voltage
Reference standard:	MIL-STD-202-301
Test conditions:	Mate the receptacle and plug connector together, then apply AC 200V(rms) between the neighboring contacts for a minute.
Pass criteria:	No creeping discharge, flashover, no insulator breakdown shall occur.

4.1. Electrical Performance

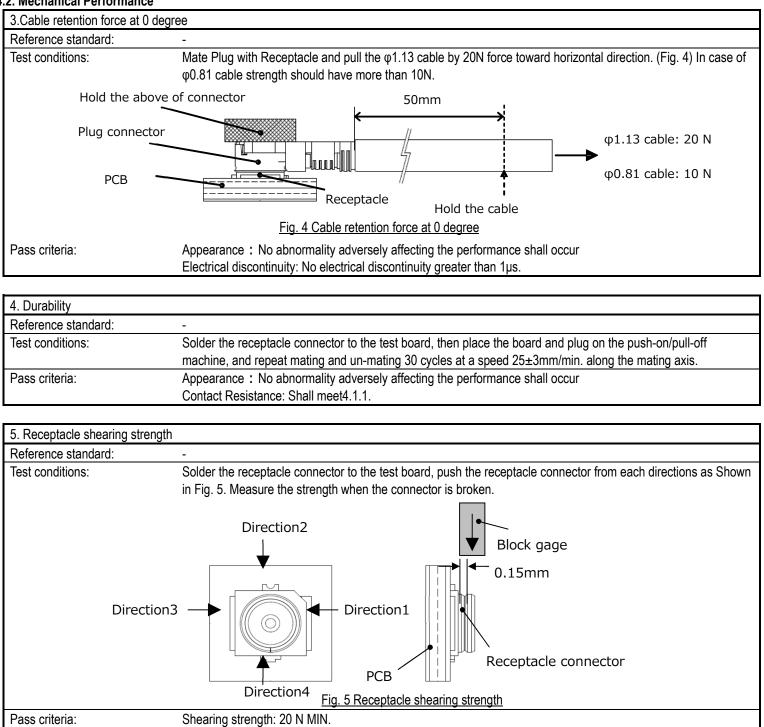


4.2. Mechanical Performance

1. Mating force and Un-ma	ating force
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on push-on/pull-off machine, measure of initial and mating/unmating 30 cycles at a speed 25±3mm/min. along the mating axis.
Pass criteria:	Mating force Initial: 30 N MAX. 30cycles: 30 N MAX. Unmating force
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4.2. Mechanical Performance



4.2. Mechanical Performance

6. Vibration	
Reference standard:	MIL-STD-202-201.
Test conditions:	Apply the following vibration to the mating connector.
	During the testing, run 100mA DC to check electrical discontinuity.
	Frequency: 10Hz \rightarrow 10Hz \checkmark 10Hz \checkmark approx 15minutes.
	Half amplitude, Peak value of acceleration: 1.5mm or 59m/s2 (6G)
	Directions, cycle: 3 mutually perpendicular direction, 5 cycles (approx 75minutes.)
	for each direction.
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.
	Appearance: No abnormality adversely affecting the performance shall occur

7.Shock		
Reference standard:	MIL-STD-202-213.	
Test conditions:	Apply the following shock to the mating connector. During the testing, run 100mA DC to check electrical discontinuity.	
	MAX.G: 735m/s ² (75G)	Directions: 6 mutually perpendicular direction
	Duration: 11msec	Cycle: 3 cycles about each direction
	Wave Form: Half Sinusoidal	
Pass criteria:	Contact resistance: Shall meet 4.1.	1.
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.	
	Appearance : No abnormality adve	ersely affecting the performance shall occur

4.3. Environmental Performance

1.Thermal shock	
Reference standard:	MIL-STD-202, Method 107, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment.
	Temperature: 218K(-55 $^{\circ}$ C),30min. \rightarrow 358K(85 $^{\circ}$ C),30min.
	Transition time: 5min. MAX.
	No. of cycles: 5 cycles
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Insulation resistance: Shall meet 4.1.2.
	Dielectric withstanding voltage: Shall meet 4.1.3.
	Appearance : No abnormality adversely affecting the performance shall occur

2. High temperature life	
Reference standard:	MIL-STD-202-108
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 363±2K (90±2°C)
Pass criteria:	Duration: 96 hours Contact resistance: Shall meet 4.1.1.
	Appearance: No abnormality adversely affecting the performance shall occur

4.3. Environmental Performance

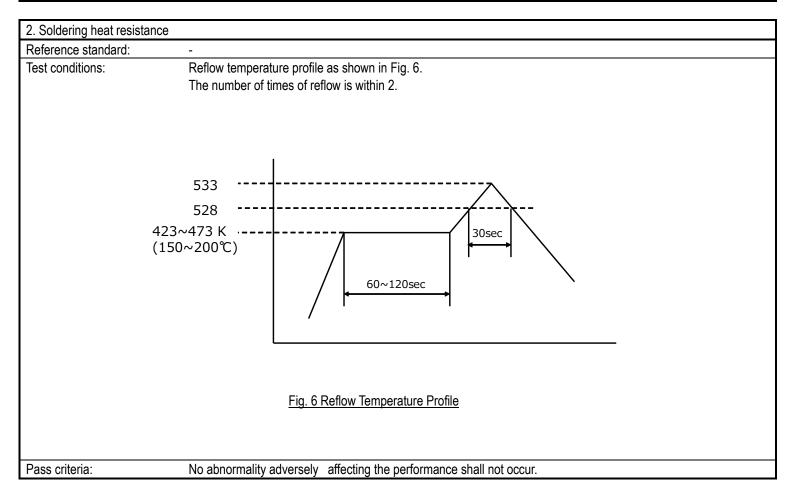
3. Humidity(Steady state)	
Reference standard:	MIL-STD-202-103, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment.
	Temperature: 313±2K (40±2°C)
	Humidity: 90~95%RH
	Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Insulation resistance: Shall meet 4.1.2.
	Dielectric withstanding voltage: Shall meet 4.1.3.
	Appearance : No abnormality adversely affecting the performance shall occur

4. Salt water spray	
Reference standard:	MIL-STD-202-101, Condition B
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 308±2K (35±2°C) Salt water density: 5±1% [by weight] Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance : No abnormality adversely affecting the performance shall occur adversely affecting the performance shall occur.

5. H ₂ S gas	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313±2K (40±2°C) Relative humidity: 80±5%RH Gas: H ₂ S 3±1ppm Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance : No abnormality adversely affecting the performance shall occur adversely affecting the performance shall occur.

4.4.Others

1. Solder ability	
Reference standard:	MIL-STD-202-208
Test conditions:	Dip the solder tine of the contact in the solder bath at 518±5K (245±5°C) for 5±0.5seconds after immersing the tine in the flux of RMA or R type for 5 to 10 seconds.
Pass criteria:	The surface of the dipped contact must become 95% wet and the non-wetted pinholes must not accumulate in one area but be distributed and must be less than 5% of the contact area to be soldered.



MHF 4 / 4L Connector Product Specification

4.5 Test Sequence and Specimen Quantity

				-	Table 1	Tes	t Seque	ence an	d Samp	le Qua	ntity						
Test Item									Gro	oup							
		А	В	С	D	E	F	G	Н	J	K	L	М	Ν	Р	Q	R
Contact resistance							1,3		1,3	1,3	1,5	1,3	1,3	1,3	1,3		
Insulation resistance											2,6		2,6				
Dielectric withstanding voltage		1									3,7		3,7				
VSWR			1														
Mating force / Unmating force				1													
Cable retention force at 30 degree					1												
Cable retention force at 0 degree						1											
Durability							2										
Receptacle shearing strength								1									
Vibration									2								
Shock										2							
Thermal shock											4						
High temperature life												2					
Humidity													4				
(Steady state) Salt water spray														2			
H ₂ S gas															2		
Solder ability																1	
Soldering heat resistance																	1
Specimen Quantity (pcs.)	Plug	10	10	40	10	10	10	-	10	10	10	10	10	10	10	-	-
	Receptacle		5	10				12								10	10

*Numbers indicate sequence in which tests are performed.

5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.

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